

# International Conference Report

**Date:** September 25, 2023    **Name:** Jhih-Wei Huang    **Department:** Chemistry

**Location/Time of Conference:** Hyogo Prefecture, Japan, Aug. 31 – Sep. 2, 2023

**Document number of Supplement Approved by the Dean of college:**

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## Name of Conference:

第九屆先進材料與應用交流研討會

The 9th TKU-ECUST-KIST-OMU-UH-IHU-KMITL-UTAR-TNU-HUFI Joint Symposium on Advanced Materials and Applications (JSAMA-9)

## Published Research:

利用咪唑基分子探針一步檢測銅離子的液晶感測器

Liquid Crystal-based Sensor for Detecting Copper Ions in One Step by Using Imidazole-based Molecular Probes

Date	Items of supplement	Amount of supplement	Remarks:
	Round-trip Tickets	15090	
	Daily Living Expenses during conference period		*Period includes the conference day, the day prior, and the day after
	Registration fees of conference		*Excluding other expenses such as printing, membership fees, reception, etc.

\*You need to upload the following documents to *Online Student Affairs Interaction Section* by downloading below-listed format files first:

1. Conference Proceedings.doc
2. Conference Reflection.doc
3. Your Publication.doc